

**REPLY UNDER 37 C.F.R. § 1.116  
EXPEDITED PROCEDURE  
TECHNOLOGY CENTER ART UNIT 2813**

Attorney Docket: 040008-0307078  
Client Reference: OF03P195/US

**RECEIVED  
CENTRAL FAX CENTER**

**JUN 28 2005**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of: LEE

Confirmation Number: 8236

Application No.: 10/733,276

Group Art Unit: 2813

Filed: December 12, 2003

Examiner: Nguyen, Thanh T.

Title: METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE WITHOUT  
OXIDIZED COPPER LAYER (AS AMENDED)

AMENDMENT AFTER FINAL REJECTION UNDER 37 C.F.R. § 1.116

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated March 30, 2005, please amend the above-identified application as follows:

Do Not Enter  
7/6/05